



ZHCS1000QTA

SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(TYP)} @ 1A (V)	I _{R(TYP)} @ V _R =30V (μΑ)
40	1	0.425	50

Features and Benefits

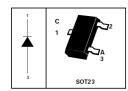
- High Current Capability $(I_F = 1A)$
- Low V_F
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Applications

- **DC-DC** Converters
- Mobile Telecomms
- **Blocking Diodes**
- **Reverse Polarity Protection**

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.0089 grams (Approximate)



Top View

Ordering Information (Note 5)

Dev	vice	Compliance	Case	Packaging	
ZHCS1	ZHCS1000QTA Automotive		SOT23	3000/Tape & Reel	
Notes: 1. No pur	lotes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.				

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

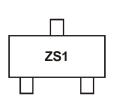
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds. 4. Automotive products are AEC-Q101 qualified and are PPAP capable. For more information, please refer to

http://www.diodes.com/product_compliance_definitions.html

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZS1 = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Continuous Reverse Voltage		VR	40	V
Average Rectified Output Current		lo	1	A
Forward Voltage @ I _F = 1A (Typ)		VF	425	mV
Average Peak Forward Current; D.C. = 50%		I _{F(AV)}	1750	mA
Non Repetitive Forward Current	t ≤ 100µs	1	12	A
	$t \le 10ms$	IFSM	5.2	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation, $T_A = +25^{\circ}C$	PD	500	mW
Junction Temperature	TJ	+125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

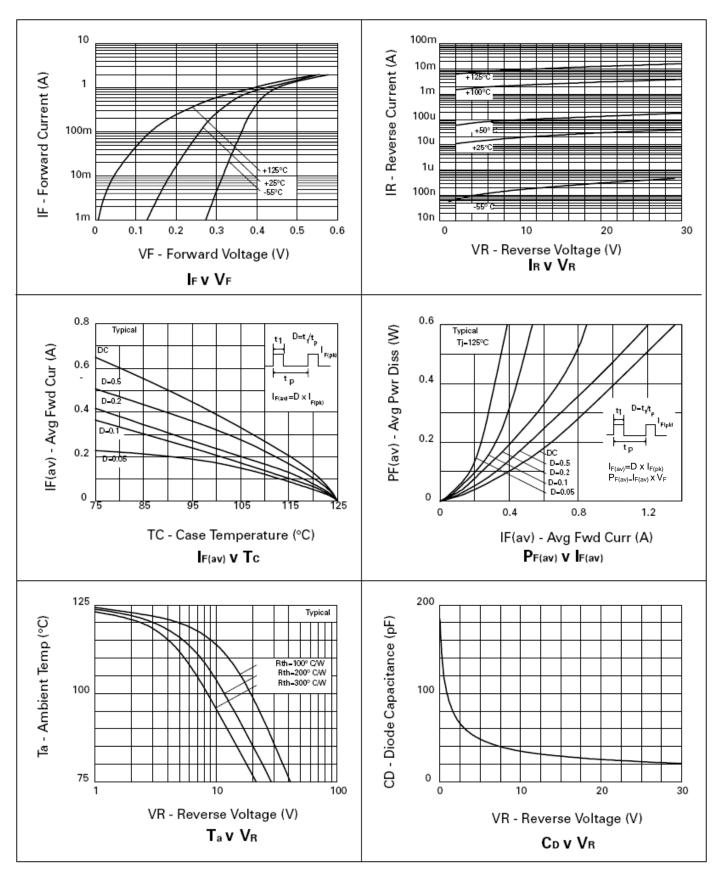
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	60	_	V	I _R = 300μA
		_	240	270	- mV	$I_F = 50 \text{mA}$
		_	265	290		I _F = 100mA
		_	305	340		I _F = 250mA
Forward Voltage (Note 6)	N/	_	355	400		I _F = 500mA
Forward voltage (Note 6)	V _F	_	390	450		I _F = 750mA
		_	425	500		$I_F = 1A$
		_	495	600		I _F = 1.5A
		_	420	_		$I_F = 1A, T_A = +100^{\circ}C$
Reverse Current (Note 7)	I _R	_	50	100	μA	$V_R = 30V$
Total Capacitance	CT	_	25	_	pF	$f = 1MHz, V_R = 30V$
Reverse Recovery Time	t _{RR}	_	12	_	ns	Switched from $I_F = 500$ mA to $I_R = 500$ mA
						Measured @ I _R = 50mA

Notes:

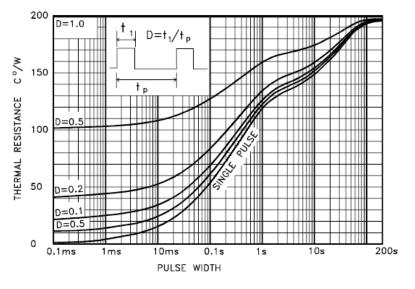
6. Measured under pulsed conditions. Pulse width = $300\mu S.$ 7. Short duration pulse test used to minimize self-heating effect.







NEW PRODUCT



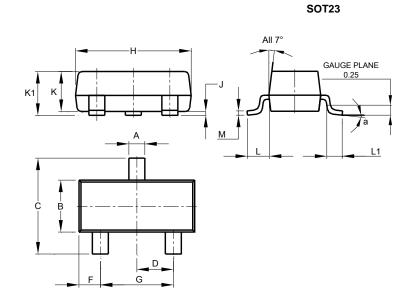
Maximum Transient Thermal Resistance*

* Devices were mounted on a 15mmx15mm ceramic substrate.



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

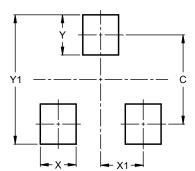


SOT23				
Dim	Min	Max	Тур	
Α	0.37	0.51	0.40	
В	1.20	1.40	1.30	
С	2.30	2.50	2.40	
D	0.89	1.03	0.915	
F	0.45	0.60	0.535	
G	1.78	2.05	1.83	
Н	2.80	3.00	2.90	
J	0.013	0.10	0.05	
K	0.890	1.00	0.975	
K1	0.903	1.10	1.025	
L	0.45	0.61	0.55	
L1	0.25	0.55	0.40	
М	0.085	0.150	0.110	
а	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SOT23



Dimensions	Value (in mm)		
С	2.0		
Х	0.8		
X1	1.35		
Y	0.9		
Y1	2.9		



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